

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2010/06/17	

Electrical Specifications @ 25℃

1. Turns Ratio ($\pm 2\%$):

TX=1CT:1CTRX=1CT:1CT

2. Inductance (@100KHz, 100mV, 8mA DC Bias): J1-J2; J3-J6; J4-J5; J7-J8: 350uH Min

3. Insertion Loss: $1\sim 100 \text{MHz}:-1.0 \text{dB Max}$

4. Return Loss (dB Min. load 100Ω):

 $1 \sim 30 \text{MHz} : -18$

CONNECTOR

RJ45

 $30 \sim 60 \text{MHz} : -16$

 $60 \sim 80 \text{MHz}:-12$

80~100MHz:-10

5. Crosstalk(dB Min):

 $1 \sim 30 \text{MHz} : -40$

 $30 \sim 60 \text{MHz} : -35$

 $60 \sim 100 \text{MHz}:-30$

6. Common Mode Rejection (dB Min):

 $1 \sim 50 \text{MHz} : -40$

 $50 \sim 150 \text{MHz} : -30$

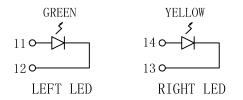
7. Isolation Voltage: 1500Vrms

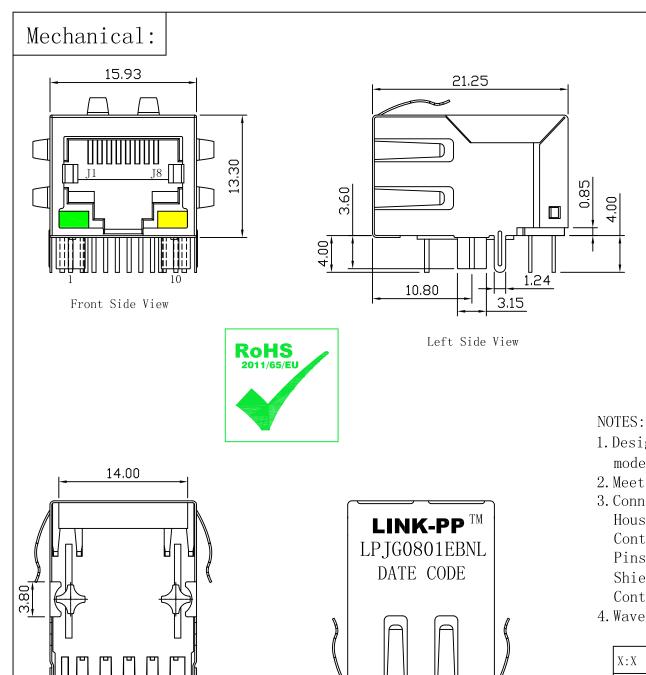
8. Operating Temperature Range: $0^{\circ}\text{C} \sim 70^{\circ}\text{C}$.



Emitting Color	λ p(nm)	VF@IF=20mA	IR @VR=5V
GREEN	565	1.8~2.6V	10
YELLOW	585	1.8~2.6V	10 μ A max

X:X	±0.30	APPD:	APPD:		LINK-PP INT'L TECHNOLOGY CO., LIMITE		
X:XX	± 0.25	CHKD:					
X:XXX	±0.05	DR:	TOM	TITL		nnector with 1000 Base-T ted Magnetics	
ANGLES	±1°	UNIT:	mm	PART	NO.: LP	JG0801EBNL	
⊕∈	→ SC.	ALE: 2/1	SHEET:	1/2	REV: A	DWG NO.: LP10061725	

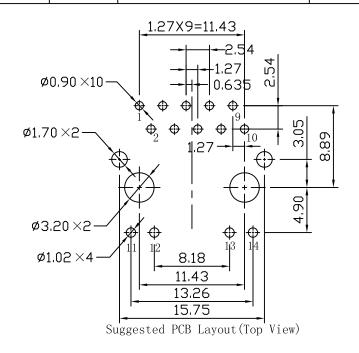




Bottow Side View

Top Side View

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- 1. Designed to support application, such as SOHO (ADSL modems), LAN-on-Motherboard (LOM), hub and Switches.
- 2. Meets IEEE802. 3 specification
- 3. Connector Materials:

Housing: Thermoplastic PBT+30%G.F UL94V-0

Contact: Phosphor Bonze C5210R-EH Thickness=0.35mm

Pins: Brass C2680R-H Thickness=0.35mm Shield: SUS 201-1/2H Thickness=0.2mm

Contact plating: Gold 6 micro-inches min. In contact area.

4. Wave solder tip temperature: 265°C Max, 5 Sec Max.

X : X	±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED		
X:XX	± 0.25	CHKD:	TITLE DIAGO DE T		
X:XXX	± 0.05	DR: TOM	TITLE: RJ45 Connector with 1000 Base-T Integrated Magnetics		
ANGLES ±1° UNIT: mm		UNIT: mm	PART NO.: LPJG0801EBNL		
⊕ ∈	SCA	LE: _{2/1} SHEET:	2/2 REV: A DWG NO.: LP10061725		